PTC thermistors as limit temperature sensors

SMD, EIA case sizes 0603 and 0805, standard series

Series/Type: **B59601, B59602, B59603, B59604, B59701**

Date: February 2012

SMD

Applications

- DC/DC converters
- Home appliances
- Dimmers
- Electronic ballasts
- Over-temperature protection of power components
- Secondary protection of battery packs
- SMPS
- Notebooks

Features

- Fast and reliable response
- Suitable for reflow soldering only
- Compliant to RoHS directive 2002/95/EC
- UL approval to UL1434 for B59601A* (file number E69802)
- Lead-free tinned terminations

Options

- Other T_{sense} or resistance values on request

Delivery mode

- Blister tape (case size 0805) or cardboard tape (case size 0603), 180-mm reel with 8-mm tape, taping to IEC 60286-3
- Packing unit: 4.000 pcs.

General technical data

Max. operating voltage		V_{max}	32	V DC
Minimum operating temperature	($V \le V_{max}$)	T_{min}	−40	°C
Maximum operating temperature	($V \le V_{max}$)	T_{max}	125 °C or $T_{sense,1}$ +25 °C whichever is higher	°C

SMD

Electrical specifications and ordering codes

Case size 0603

R_R ($V \leq V_{max}$) Ω	ΔR_R %	$T_{sense,1}$ (@ 4.7 kΩ) °C	R ($T_{sense,1}$ +10 °C) kΩ	Ordering code
EIA case size 0603, standard types				
470	±50	75 ±5	-	B59601A0075A062
470	±50	85 ±5	-	B59601A0085A062
470	±50	95 ±5	-	B59601A0095A062
470	±50	105 ±5	-	B59601A0105A062
470	±50	115 ±5	-	B59601A0115A062
470	±50	125 ±5	-	B59601A0125A062
470	±50	135 ±5	-	B59601A0135A062
EIA case size 0603, tight temperature tolerance types				
470	±50	75 ±3	-	B59601A0075B062
470	±50	85 ±3	≥ 15	B59601A0085B062
470	±50	95 ±3	≥ 40	B59601A0095B062
470	±50	105 ±3	≥ 40	B59601A0105B062
470	±50	115 ±3	≥ 40	B59601A0115B062
470	±50	125 ±3	≥ 40	B59601A0125B062
470	±50	135 ±3	≥ 40	B59601A0135B062

Note:
In order to limit self heating effects the electrical power during measurement should be below 4 mW for case size 0603.

Electrical specifications and ordering codes

Case size 0603 and 0805

R_R ($V \leq V_{max}$) Ω	ΔR_R %	T_{sense} °C	R ($T_{sense,1}$ −5°C) kΩ	R ($T_{sense,1}$ +5°C) kΩ	R ($T_{sense,1}$ +15°C) kΩ	Ordering code
EIA case size 0603, tight resistance tolerance types						
110	±15	70	≤ 1.1	≥ 1.1	-	B59602A0055B062
470	±15	55	≤ 4.7	≥ 4.7	-	B59603A0055A062
470	±15	85	≤ 4.7	≥ 4.7	-	B59603A0085A062
470	±15	105	≤ 4.7	≥ 4.7	-	B59603A0105A062
EIA case size 0805, standard types						
680	±50	70	≤ 5.7	≥ 5.7	≥ 40[1)]	B59701A0070A062
680	±50	90	≤ 5.5	≥ 13.3	≥ 40	B59701A0090A062
680	±50	100	≤ 5.5	≥ 13.3	≥ 40	B59701A0100A062
680	±50	110	≤ 5.5	≥ 13.3	≥ 40	B59701A0110A062
680	±50	120	≤ 5.5	≥ 13.3	≥ 40	B59701A0120A062
680	±50	130	≤ 5.5	≥ 13.3	≥ 40	B59701A0130A062
680	±50	140	≤ 5.5	≥ 13.3	≥ 40	B59701A0140A062

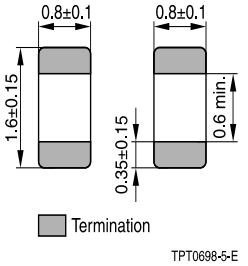
Note:
In order to limit self heating effects the electrical power during measurement should be below 4 mW for case size 0603 and below 6 mW for case size 0805.

1) R ($T_{sense,1}$ +25 °C)

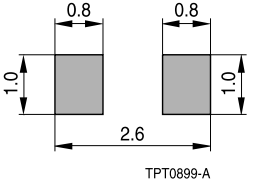
SMD

Dimensional drawings in mm

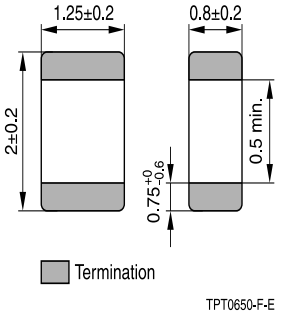
EIA case size 0603



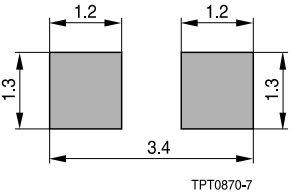
Solder pad



EIA case size 0805



Solder pad

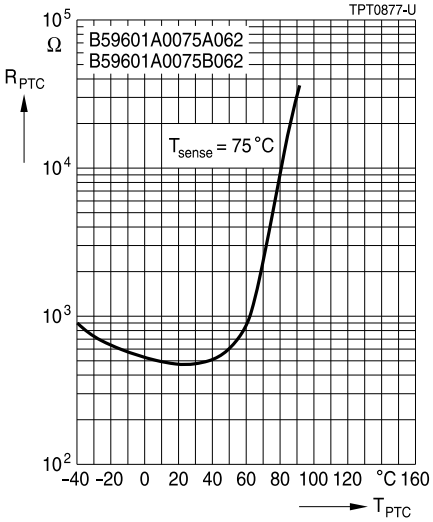


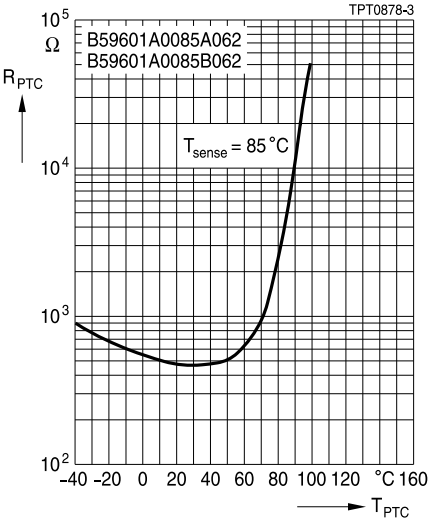
Recommended maximum dimensions (mm)

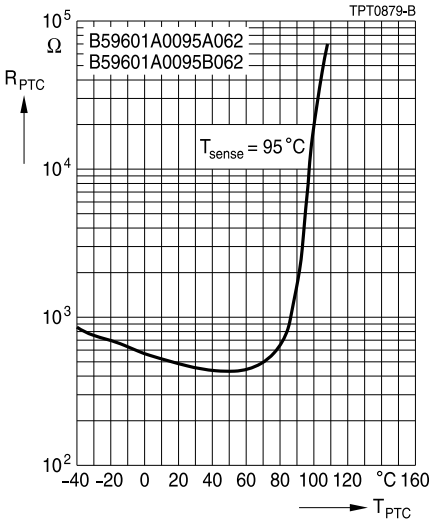
SMD

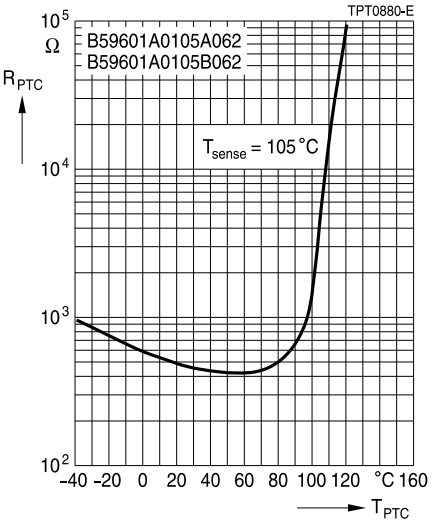
Characteristics (typical) for type A601

PTC resistance R_{PTC} versus
PTC temperature T_{PTC}
(measured at low signal voltage)





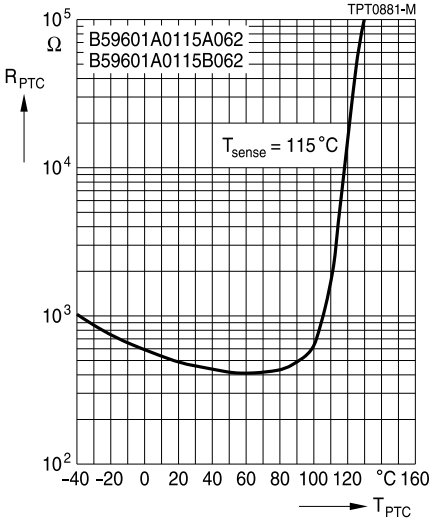


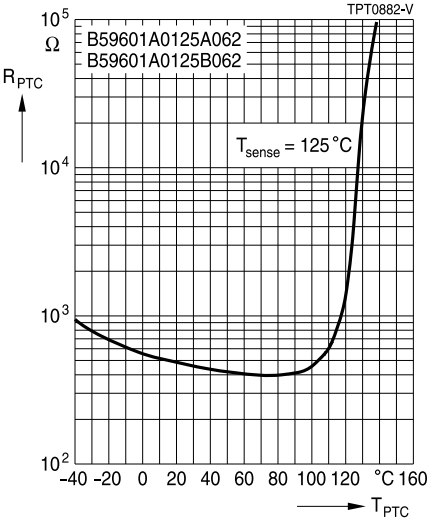


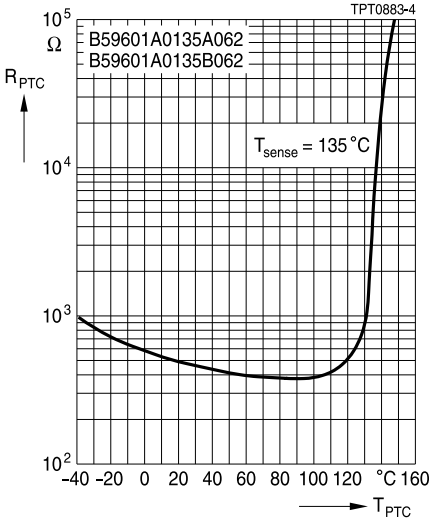
SMD

Characteristics (typical) for type A601

PTC resistance R_{PTC} versus
PTC temperature T_{PTC}
(measured at low signal voltage)

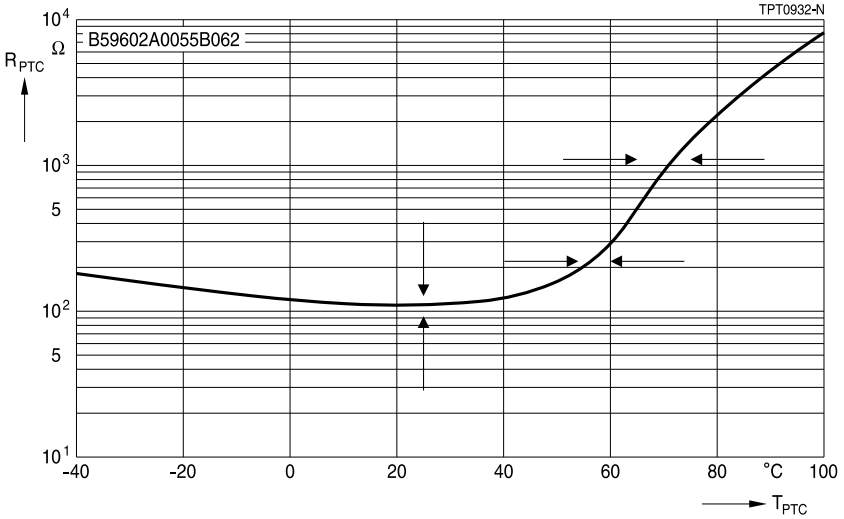


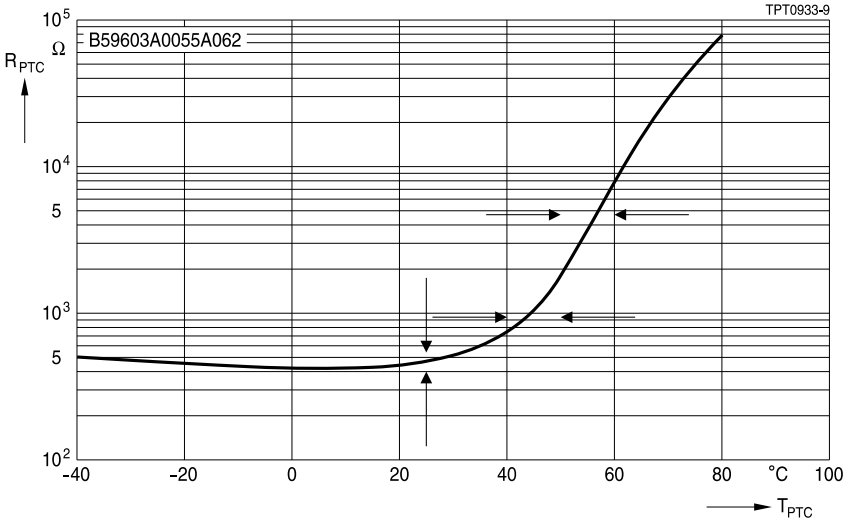




Characteristics (typical) for type A602 and A603

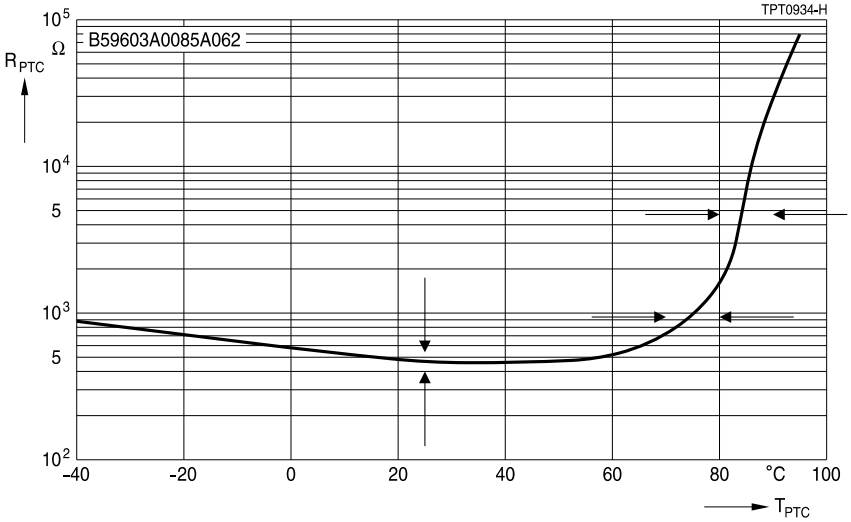
PTC resistance R_{PTC} versus PTC temperature T_{PTC}
(measured at low signal voltage)

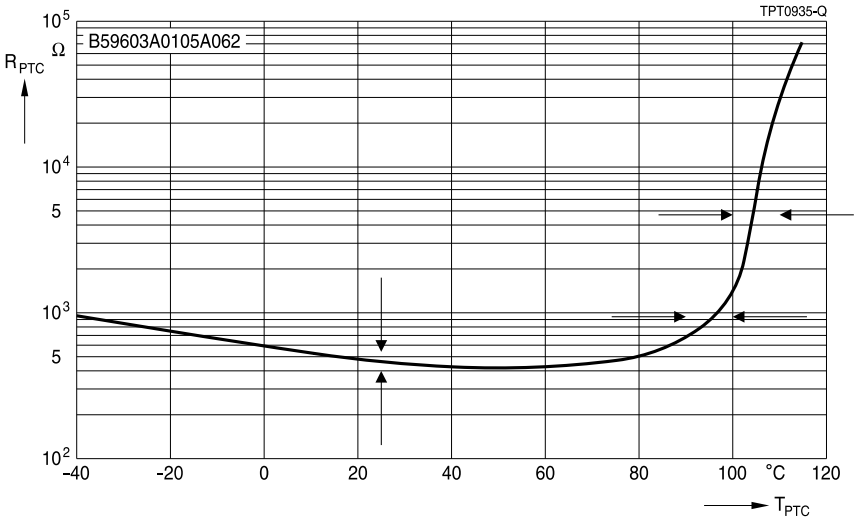




Characteristics (typical) for type A603

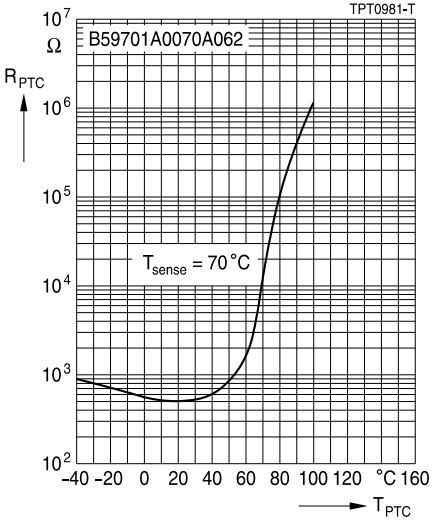
PTC resistance R_{PTC} versus PTC temperature T_{PTC}
(measured at low signal voltage)

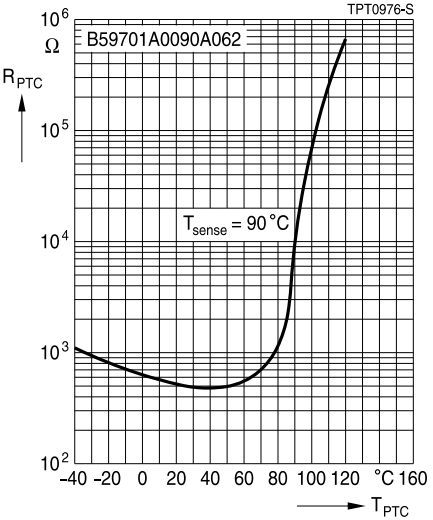


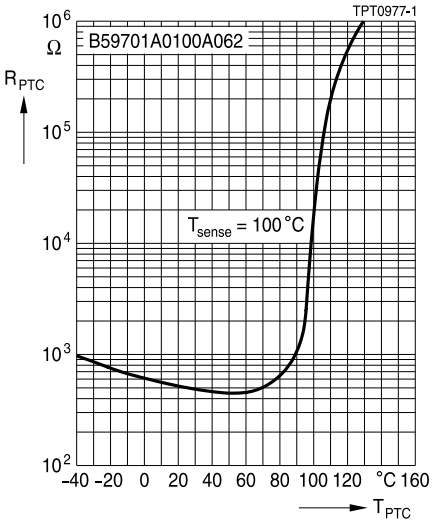


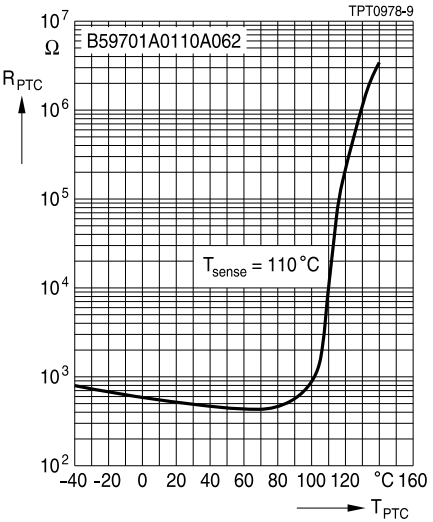
Characteristics (typical) for type A701

PTC resistance R_{PTC} versus PTC temperature T_{PTC}
(measured at low signal voltage)





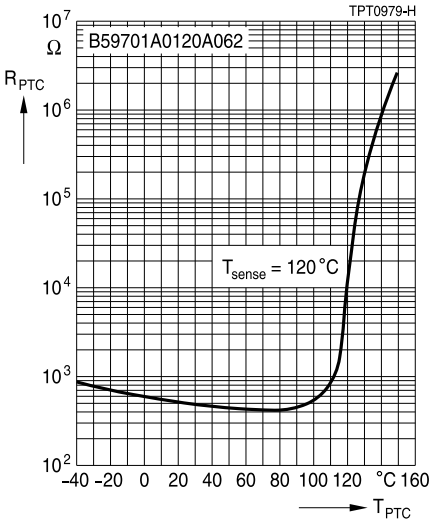


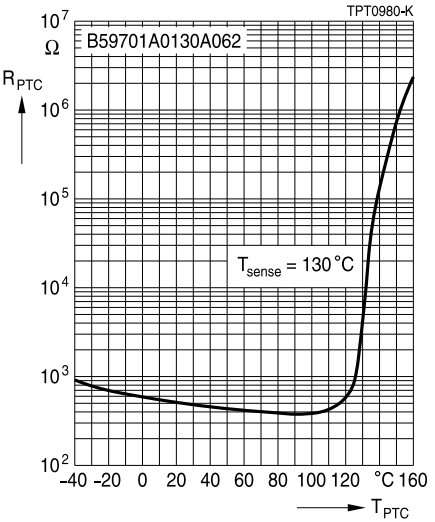


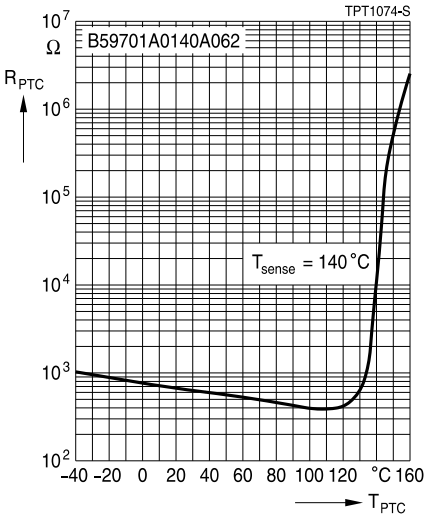
SMD

Characteristics (typical) for type A701

PTC resistance R_{PTC} versus PTC temperature T_{PTC}
(measured at low signal voltage)







Reliability data

Test	Standard	Test conditions	$\lvert\Delta R_{25}/R_{25}\rvert$
Electrical endurance, cycling	IEC 60738-1	Room temperature: I_{smax} , V_{max}; Number of cycles: 100	< 20%
Electrical endurance, constant	IEC 60738-1	Storage at V_{max}/T_{op} Test duration : 1000 h	< 25%
Damp heat	IEC 60738-1	Temperature of air: 40 °C Relative humidity of air: 93% Duration: 56 days Test according to IEC 60068-2-78	< 10%
Rapid change of temperature	IEC 60738-1	$T_{LCT} = -40$ °C, $T_{UCT} = 125$ °C Number of cycles: 5 Test duration: 30 min Test according to IEC 60068-2-14, test Na	< 10%
Vibration	IEC 60738-1	Frequency: 10 - 55 - 10 Hz Displacement amplitude: 0.75 mm Test duration: 3 × 2 h Test according to IEC 60028-2-6, test Fc	< 5%
Shock	IEC 60738-1	Pulse shape: half-sine Acceleration: 390 m/s² Pulse duration: 6 ms; 6 x 4000 pulses Test according to IEC 60068-2-27, test Ea	< 5%
Climatic sequence	IEC 60738-1	Dry heat: $T_{UCT} = 125$ °C Test duration: 16 h Damp heat first cycle Cold: $T_{LCT} = -40$ °C Test duration: 2 h Damp heat 5 cycles Tests performed according to IEC 60068-2-30	< 10%
Bending test	IEC 60738-1	Components reflow-soldered to test board Maximum bendig: 2 mm Test according to IEC 60068-2-21, test Ue	< 5%
Adhesive strength on PCB		Shearing of the component soldered on PCB by a force of 5 N normal to components longitudinal axis	No visible damage

Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package before storage.
- Storage conditions in original packaging: storage temperature −25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
  - Through-hole devices (housed and leaded PTCs): 24 months
  - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
  - Telecom pair and quattro protectors (TPP, TQP): 24 months
  - Leadless PTC thermistors for pressure contacting: 12 months
  - Leadless PTC thermistors for soldering: 6 months
  - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
  - SMDs in EIA sizes 0402, 0603, 0805 and 1210: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- Components must not be touched with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.

Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.

SMD

Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force of the clamping contacts pressing against the PTC must be 10 N.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).

Symbols and terms

A	Area
C	Capacitance
C_{th}	Heat capacity
f	Frequency
I	Current
I_{max}	Maximum current
I_R	Rated current
I_{res}	Residual current
I_{PTC}	PTC current
I_r	Residual currrent
$I_{r,oil}$	Residual currrent in oil (for level sensors)
$I_{r,air}$	Residual currrent in air (for level sensors)
I_{RMS}	Root-mean-square value of current
I_S	Switching current
I_{Smax}	Maximum switching current
LCT	Lower category temperature
N	Number (integer)
N_c	Operating cycles at V_{max}, charging of capacitor
N_f	Switching cycles at V_{max}, failure mode
P	Power
P_{25}	Maximum power at 25 °C
P_{el}	Electrical power
P_{diss}	Dissipation power
R_G	Generator internal resistance
R_{min}	Minimum resistance
R_R	Rated resistance
ΔR_R	Tolerance of R_R
R_P	Parallel resistance
R_{PTC}	PTC resistance
R_{ref}	Reference resistance
R_S	Series resistance
R_{25}	Resistance at 25 °C
$R_{25,match}$	Resistance matching per reel/ packing unit at 25 °C
ΔR_{25}	Tolerance of R_{25}
T	Temperature
t	Time
T_A	Ambient temperature
t_a	Thermal threshold time

T_C	Ferroelectric Curie temperature
t_E	Settling time (for level sensors)
T_R	Rated temperature
T_{sense}	Sensing temperature
T_{op}	Operating temperature
T_{PTC}	PTC temperature
t_R	Response time
T_{ref}	Reference temperature
T_{Rmin}	Temperature at minimum resistance
t_S	Switching time
T_{surf}	Surface temperature
UCT	Upper category temperature
V or V_{el}	Voltage (with subscript only for distinction from volume)
$V_{c(max)}$	Maximum DC charge voltage of the surge generator
$V_{F,max}$	Maximum voltage applied at fault conditions in protection mode
V_{RMS}	Root-mean-square value of voltage
V_{BD}	Breakdown voltage
V_{ins}	Insulation test voltage
$V_{link,max}$	Maximum link voltage
V_{max}	Maximum operating voltage
$V_{max,dyn}$	Maximum dynamic (short-time) operating voltage
V_{meas}	Measuring voltage
$V_{meas,max}$	Maximum measuring voltage
V_R	Rated voltage
V_{PTC}	Voltage drop across a PTC thermistor
α	Temperature coefficient
Δ	Tolerance, change
δ_{th}	Dissipation factor
τ_{th}	Thermal cooling time constant
λ	Failure rate
e	Lead spacing (in mm)

Abbreviations / Notes

SMD Surface-mount devices

* To be replaced by a number in ordering codes, type designations etc.

+ To be replaced by a letter

All dimensions are given in mm.

The commas used in numerical values denote decimal points.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.epcos.com/material). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
6. Unless otherwise agreed in individual contracts, **all orders are subject to the current version of the "General Terms of Delivery for Products and Services in the Electrical Industry" published by the German Electrical and Electronics Industry Association (ZVEI)**.
7. The trade names EPCOS, BAOKE, Alu-X, CeraDiode, CSMP, CSSP, CTVS, DeltaCap, DigiSiMic, DSSP, FormFit, MiniBlue, MiniCell, MKD, MKK, MLSC, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SIP5D, SIP5K, ThermoFuse, WindCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.epcos.com/trademarks.